## *ME2307/ME2307-G*

### P-Channel 30V (D-S) MOSFET

#### **GENERAL DESCRIPTION**

The ME2307 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where low in-line power loss are needed in a very small outline surface mount package.

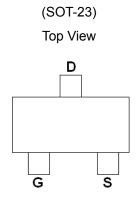
### **FEATURES**

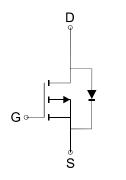
- RDS(ON)  $\leq$  70mΩ@VGS=-10V
- RDS(ON)  $\leq$ 95mΩ@VGS=-4.5V
- Super high density cell design for extremely low RDS(ON)

### **APPLICATIONS**

- Power Management in Note book
- Portable Equipment
- **Battery Powered System**
- Load Switch
- DSC

#### PIN **CONFIGURATION**





P-Channel MOSFET

Ordering Information: ME2307 (Pb-free)

ME2307-G (Green product-Halogen free)

### **Absolute Maximum Ratings** (TA=25°C Unless Otherwise Noted)

Parameter		Symbol	Maximum Ratings	Unit	
Drain-Source Voltage		VDS	-30	V	
Gate-Source Voltage		Vgs	±20	V	
Continuous Drain Current *	Ta=25°C	1_	-3.5	Α	
	Ta=70°C	- ID	-2.8		
Pulsed Drain Current		Ірм	-14	Α	
Maximum Power Dissipation	Ta=25°C	D-	1.4	W	
	Ta=70°C	PD	0.9		
Operating Junction Temperature		TJ	-55 to 150	°C	
Thermal Resistance-Junction to Ambient*		RθJA	90	°C/W	

<sup>\*</sup> The device mounted on 1in<sup>2</sup> FR4 board with 2 oz copper







# ME2307/ME2307-G

### P-Channel 30V (D-S) MOSFET

**Electrical Characteristics** (TA = 25°C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Тур	Max	Unit	
STATIC		<u> </u>	•	•	1	•	
V(BR)DSS	Drain-Source Breakdown Voltage	Vgs=0V, ID=-250 μ A	-30			V	
VGS(th)	Gate Threshold Voltage	Vps=Vgs, Ip=-250 μ A	-1		-3	V	
Igss	Gate Leakage Current	Vps=0V, Vgs=±20V			±100	nA	
IDSS	Zero Gate Voltage Drain Current	Vps=-30V, Vgs=0V			-1	$\mu$ A	
RDS(ON)	Drain-Source On-Resistance a	Vgs=-10V, ID= -3.2A		58	70	mΩ	
	Drain-Source On-Resistance	V <sub>G</sub> S=-4.5V, I <sub>D</sub> = -2.5A		75	95		
VsD	Diode Forward Voltage	Is=-1A, Vgs=0V		-0.8	-1.2	V	
DYNAMIC							
Qg	Total Gate Charge	V <sub>DS</sub> =-15V,V <sub>GS</sub> =-10V,I <sub>D</sub> =-1.7A		14	18	nC	
Qg	Total Gate Charge			6.8			
Qgs	Gate-Source Charge	V <sub>D</sub> S=-15V, V <sub>G</sub> S=-4.5V, I <sub>D</sub> =-1.7A		2.8			
Qgd	Gate-Drain Charge			2.3			
Rg	Gate resistance	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz		3.5	4.5	Ω	
Ciss	Input Capacitance	\/ 15\/ \/0\/		460	540	pF	
Coss	Output Capacitance	VDS=-15V, VGS=0V, f=1MHz		74			
Crss	Reverse Transfer Capacitance	I- IIVIDZ		23			
td(on)	Turn-On Delay Time			33	43		
tr	Turn-On Rise Time	VDS=-15V, RL =15 $\Omega$		17	22	ns	
td(off)	Turn-Off Delay Time	RGEN= $6\Omega$ , VGS=- $10V$		39	52		
<b>t</b> f	Turn-Off Fall time			5	6.5		

Notes: a. Pulse test: pulse width  $\leq$  300us, duty cycle  $\leq$  2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.

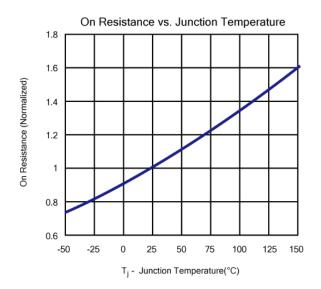


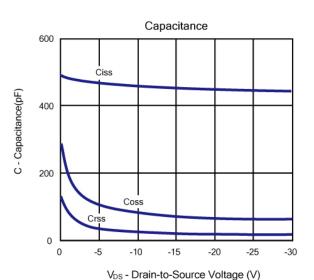


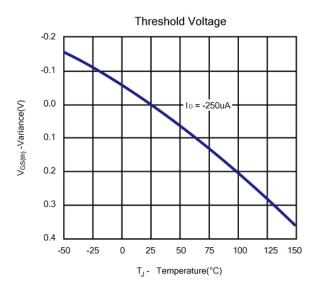


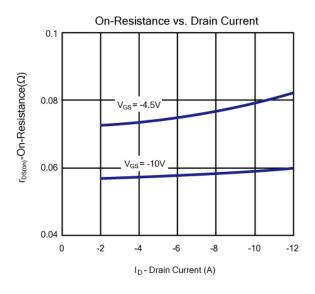
### P-Channel 30V (D-S) MOSFET

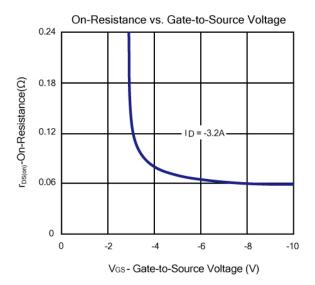
### Typical Characteristics (TJ =25°C Noted)

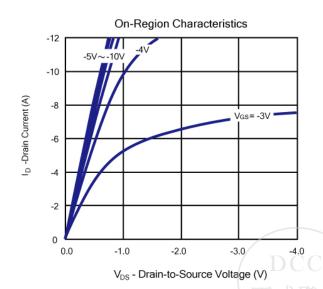










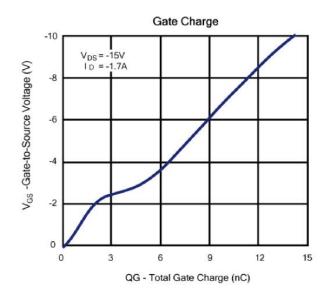


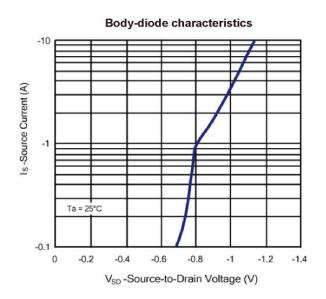


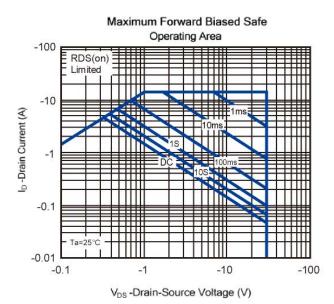


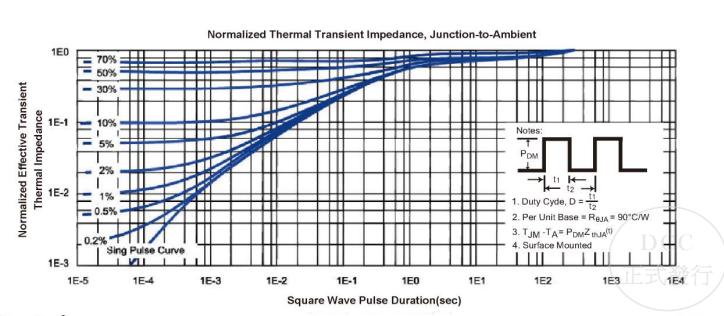
### P-Channel 30V (D-S) MOSFET

### Typical Characteristics (TJ =25°C Noted)





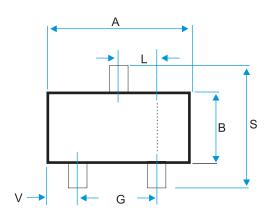


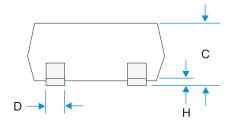


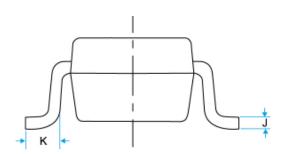


P-Channel 30V (D-S) MOSFET

### **SOT-23 Package Outline**







DIM	MILLIMETERS (mm)			
DIM	MIN	MAX		
Α	2.800	3.00		
В	1.200	1.70		
С	0.900	1.30		
D	0.350	0.50		
G	1.780	2.04		
Н	0.010	0.15		
J	0.085	0.20		
K	0.300	0.65		
L	0.890	1.02		
S	2.100	3.00		
V	0.450	0.60		

